



SANYO Semiconductors

# DATA SHEET

An ON Semiconductor Company

## 2SC5245A — NPN Epitaxial Planar Silicon Transistor UHF to S-Band Low-Noise Amplifier OSC Applications

### Features

- Low-noise : NF=0.9dB typ (f=1GHz)  
: NF=1.4dB typ (f=1.5GHz)
- High gain :  $|S_{21e}|^2=10\text{dB typ (f=1.5GHz)}$
- High cut-off frequency :  $f_T=8\text{GHz typ}$
- Low-voltage, low-current operation (VCE=1V, IC=1mA)  
:  $f_T=3.5\text{GHz typ}$   
:  $|S_{21e}|^2=5.5\text{dB typ (f=1.5GHz)}$

### Specifications

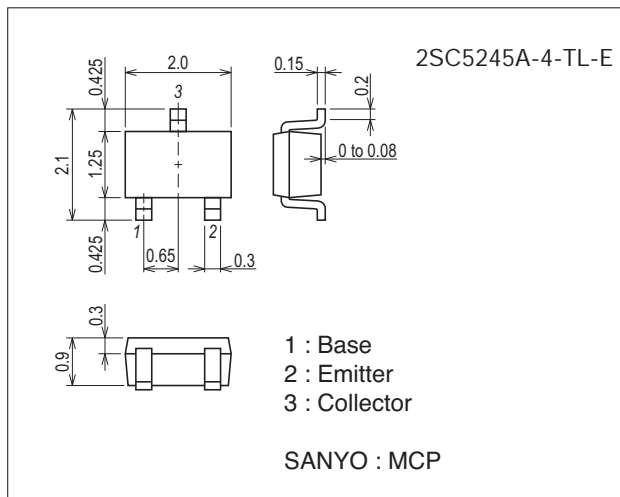
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V <sub>CBO</sub>		20	V
Collector-to-Emitter Voltage	V <sub>CEO</sub>		10	V
Emitter-to-Base Voltage	V <sub>EBO</sub>		1.5	V
Collector Current	I <sub>C</sub>		30	mA
Collector Dissipation	P <sub>C</sub>		150	mW
Junction Temperature	T <sub>j</sub>		150	°C
Storage Temperature	T <sub>stg</sub>		-55 to +150	°C

### Package Dimensions

unit : mm (typ)

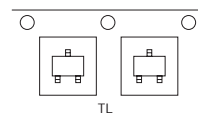
7023A-009



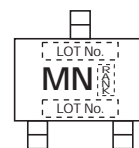
### Product & Package Information

- Package : MCP
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

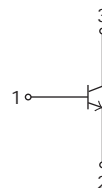
### Packing Type: TL



### Marking



### Electrical Connection



# 2SC5245A

## Electrical Characteristics at Ta=25°C

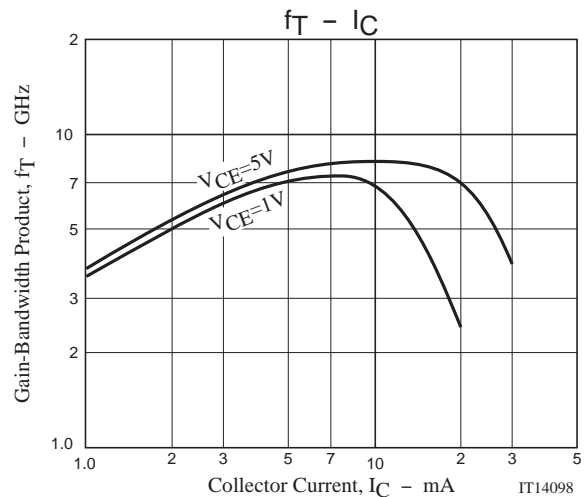
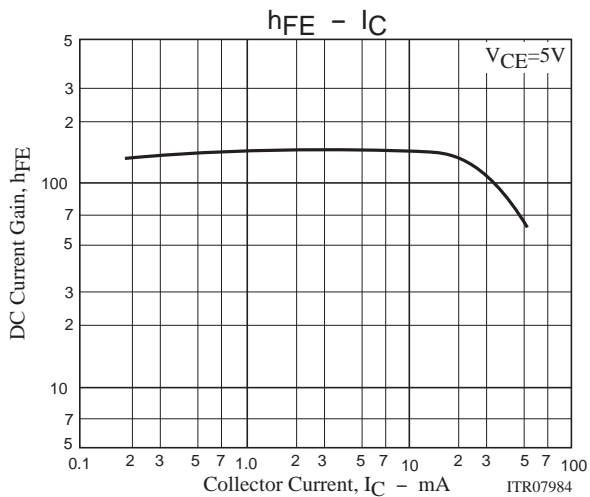
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	ICBO	V <sub>CB</sub> =10V, I <sub>E</sub> =0A			1.0	μA
Emitter Cutoff Current	IEBO	V <sub>EB</sub> =1V, I <sub>C</sub> =0A			10	μA
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =10mA	60*		270*	
Gain-Bandwidth Product	f <sub>T1</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =10mA	5	8		GHz
	f <sub>T2</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =1mA		3.5		GHz
Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> =10V, f=1MHz		0.45	0.7	pF
Reverse Transfer Capacitance	C <sub>re</sub>				0.30	
Forward Transfer Gain	S <sub>21e</sub>   <sup>2</sup> <sub>1</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =10mA, f=1.5GHz	8	10		dB
	S <sub>21e</sub>   <sup>2</sup> <sub>2</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =1mA, f=1.5GHz		5.5		dB
Noise Figure	NF1	V <sub>CE</sub> =5V, I <sub>C</sub> =5mA, f=1.5GHz		1.4	3.0	dB
	NF2	V <sub>CE</sub> =2V, I <sub>C</sub> =3mA, f=1GHz		0.9		dB

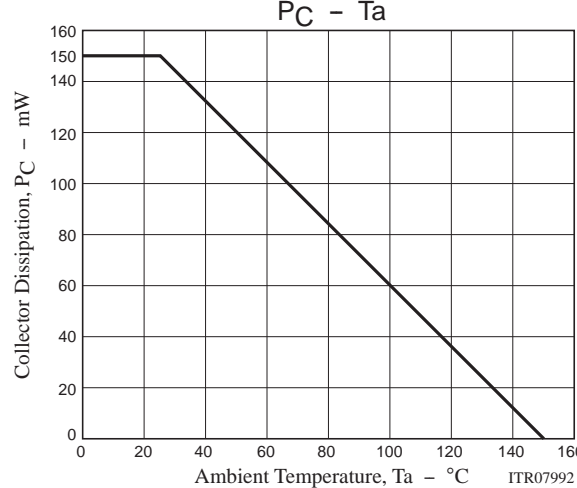
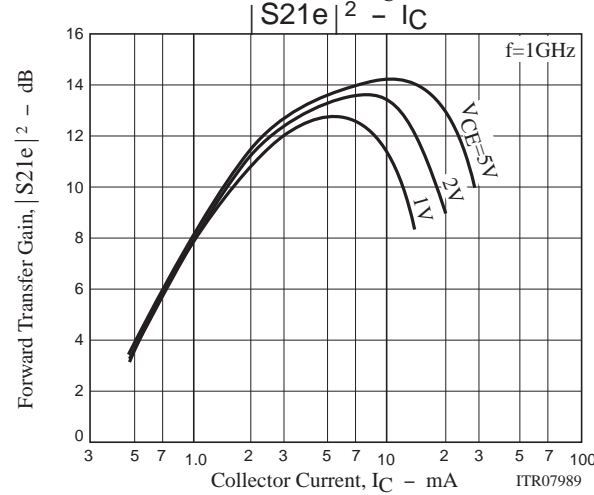
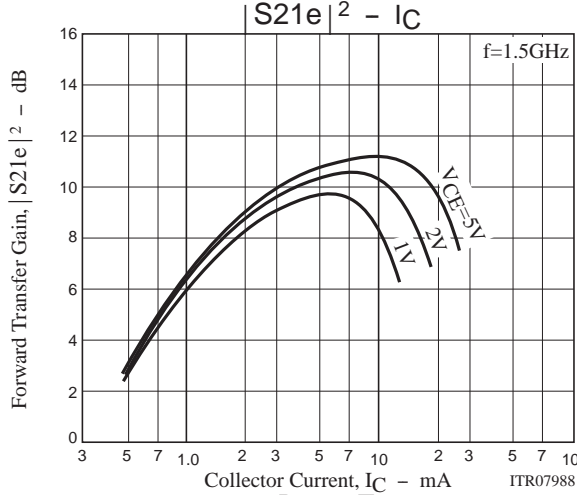
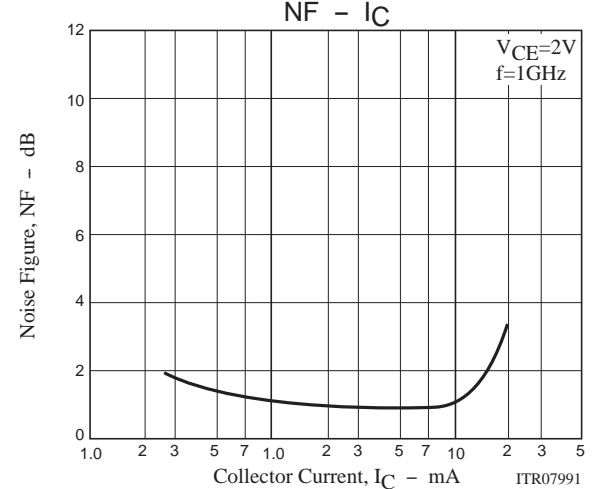
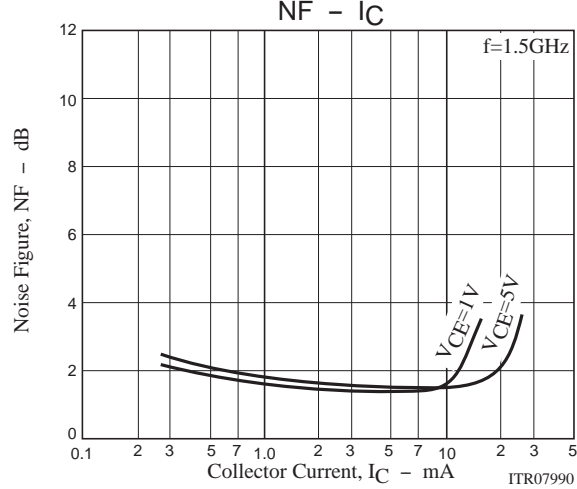
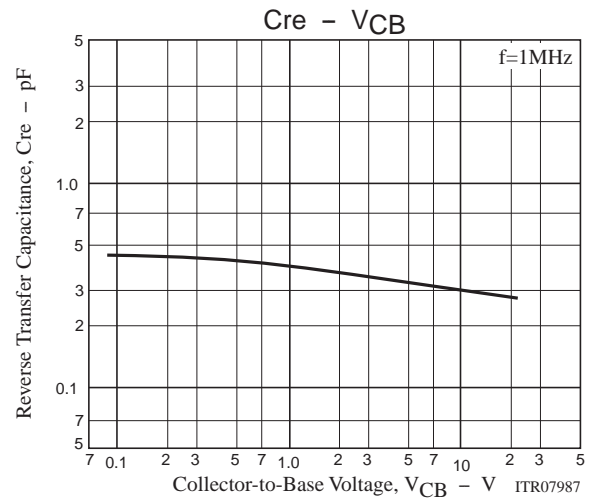
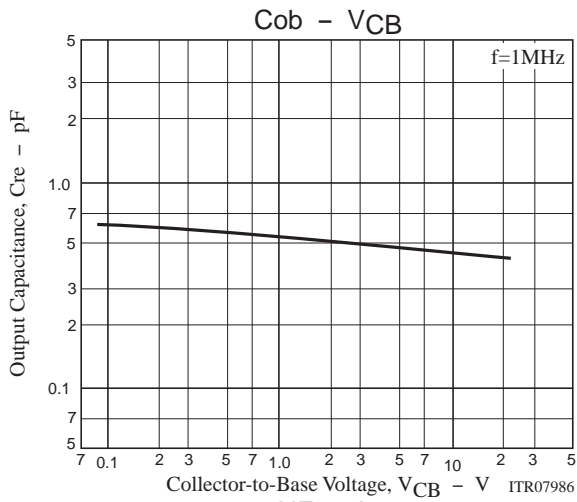
\* : The 2SC5245A is classified by 10mA h<sub>FE</sub> as follows :

Rank	3	4	5
h <sub>FE</sub>	60 to 120	90 to 180	135 to 270

## Ordering Information

Device	Package	Shipping	memo
2SC5245A-4-TL-E	MCP	3,000pcs./reel	Pb Free

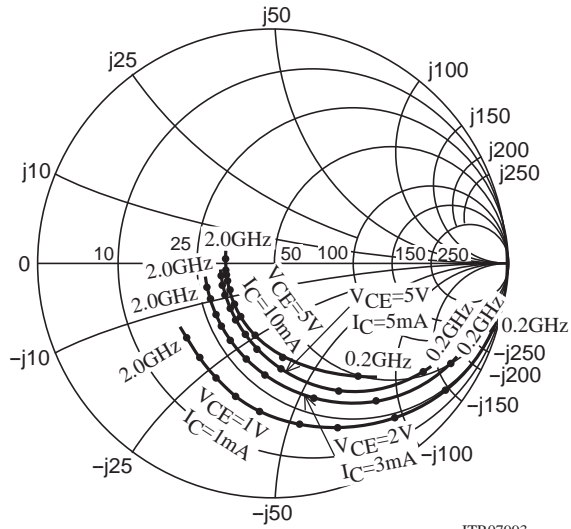




# 2SC5245A

S11e

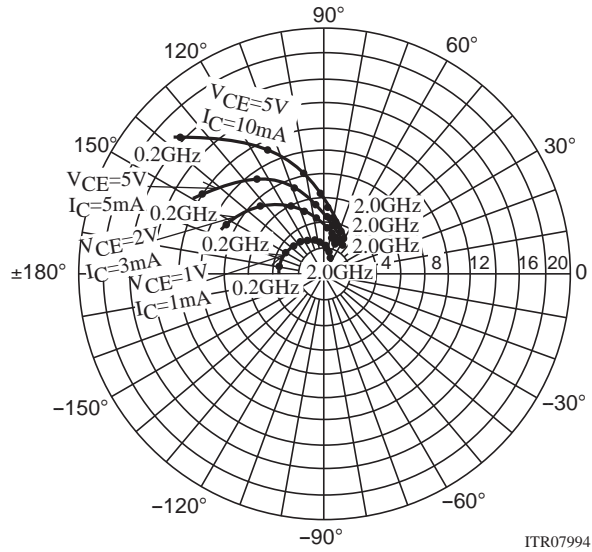
f=200MHz to 2000MHz(200MHz Step)



ITR07993

S21e

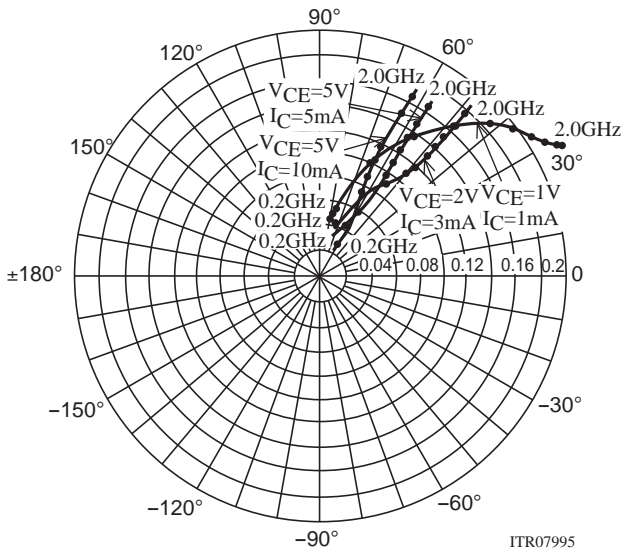
f=200MHz to 2000MHz(200MHz Step)



ITR07994

S12e

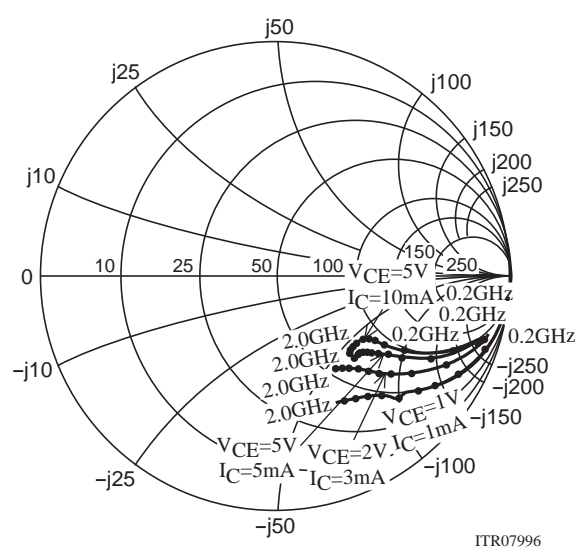
f=200MHz to 2000MHz(200MHz Step)



ITR07995

S22e

f=200MHz to 2000MHz(200MHz Step)



ITR07996

## 2SC5245A

### S Parameters (Common emitter)

$V_{CE}=5V, I_C=5mA, Z_O=50\Omega$

Freq(MHz)	S11	$\angle S11$	S21	$\angle S21$	S12	$\angle S12$	S22	$\angle S22$
200	0.763	-37.5	11.926	146.9	0.036	70.7	0.892	-19.1
400	0.590	-65.4	9.202	124.3	0.058	60.9	0.740	-29.1
600	0.456	-85.5	7.173	109.4	0.073	57.4	0.631	-33.7
800	0.374	-102.0	5.743	98.7	0.086	56.7	0.566	-35.8
1000	0.323	-115.0	4.785	90.5	0.098	56.7	0.528	-37.2
1200	0.288	-127.5	4.105	83.6	0.110	57.2	0.505	-38.4
1400	0.264	-137.7	3.599	77.5	0.123	57.7	0.488	-39.6
1600	0.248	-147.4	3.213	71.3	0.136	57.6	0.476	-41.2
1800	0.239	-156.9	2.905	66.4	0.150	57.6	0.466	-43.3
2000	0.235	-165.7	2.651	61.3	0.165	57.2	0.462	-45.4

$V_{CE}=5V, I_C=10mA, Z_O=50\Omega$

Freq(MHz)	S11	$\angle S11$	S21	$\angle S21$	S12	$\angle S12$	S22	$\angle S22$
200	0.605	-52.6	16.354	136.2	0.031	67.5	0.804	-23.9
400	0.417	-84.6	11.011	113.3	0.048	62.4	0.622	-30.5
600	0.319	-106.3	8.026	100.5	0.062	62.2	0.533	-32.0
800	0.266	-124.6	6.250	91.3	0.076	63.4	0.491	-32.4
1000	0.238	-136.5	5.115	84.7	0.090	64.3	0.469	-33.2
1200	0.225	-148.9	4.336	78.8	0.104	64.4	0.458	-34.6
1400	0.215	-158.3	3.813	73.4	0.119	64.5	0.449	-35.8
1600	0.213	-167.3	3.365	68.1	0.135	63.8	0.443	-37.7
1800	0.212	-175.6	3.030	63.5	0.150	63.1	0.436	-39.6
2000	0.216	-177.5	2.754	58.9	0.166	62.5	0.438	-41.9

$V_{CE}=2V, I_C=3mA, Z_O=50\Omega$

Freq(MHz)	S11	$\angle S11$	S21	$\angle S21$	S12	$\angle S12$	S22	$\angle S22$
200	0.842	-30.7	8.491	153.0	0.044	72.5	0.931	-17.1
400	0.704	-56.3	7.161	131.9	0.075	60.9	0.808	-28.8
600	0.579	-76.1	5.879	116.3	0.095	54.1	0.696	-36.2
800	0.480	-93.1	4.882	104.2	0.109	51.0	0.615	-40.6
1000	0.417	-106.3	4.154	95.0	0.121	49.3	0.564	-43.5
1200	0.376	-119.6	3.597	87.1	0.132	48.7	0.526	-45.8
1400	0.343	-130.2	3.212	80.2	0.143	48.6	0.496	-47.5
1600	0.319	-140.5	2.875	73.4	0.154	48.7	0.475	-49.6
1800	0.303	-150.0	2.604	67.7	0.166	48.6	0.461	-51.6
2000	0.298	-160.0	2.383	62.1	0.179	48.9	0.451	-52.9

$V_{CE}=1V, I_C=1mA, Z_O=50\Omega$

Freq(MHz)	S11	$\angle S11$	S21	$\angle S21$	S12	$\angle S12$	S22	$\angle S22$
200	0.945	-18.9	3.296	162.5	0.054	77.2	0.980	-11.0
400	0.884	-37.3	3.206	145.9	0.102	65.9	0.934	-20.5
600	0.810	-53.6	2.942	131.2	0.139	56.3	0.870	-29.0
800	0.728	-69.4	2.711	117.8	0.166	48.6	0.811	-35.5
1000	0.667	-82.5	2.449	107.0	0.187	42.5	0.763	-40.9
1200	0.605	-95.8	2.252	96.9	0.199	37.3	0.715	-45.7
1400	0.561	-106.1	2.061	88.1	0.207	33.5	0.673	-49.4
1600	0.518	-117.2	1.909	79.5	0.212	30.6	0.638	-53.4
1800	0.492	-127.5	1.766	72.2	0.215	28.6	0.611	-56.5
2000	0.465	-137.9	1.658	65.2	0.217	27.6	0.592	-59.9

# 2SC5245A

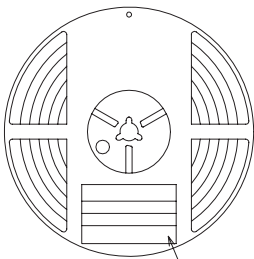
## Embossed Taping Specification

2SC5245A-4-TL-E

### 1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCP	MCP	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

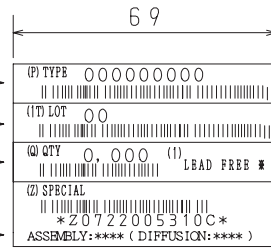
#### Packing method



Reel label

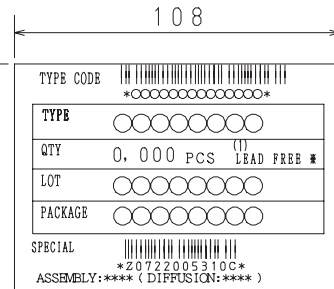
Type No.  
LOT No.  
Quantity  
Origin

Reel label, Inner box label  
(unit: mm)



Outer box label

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



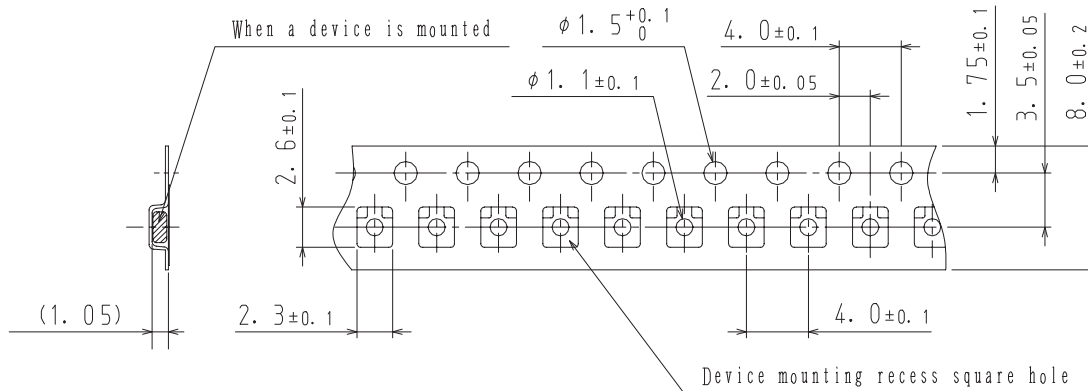
NOTE (1)

The LEAD FREE ⚡ description shows that the surface treatment of the terminal is lead free.

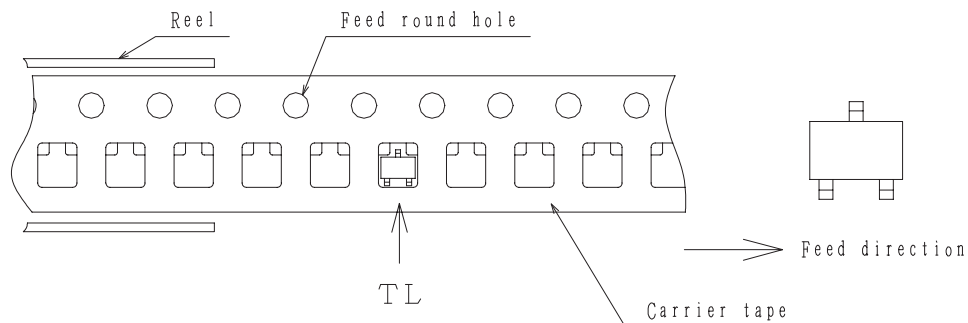
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

### 2. Taping configuration

#### 2-1. Carrier tape size (unit:mm)



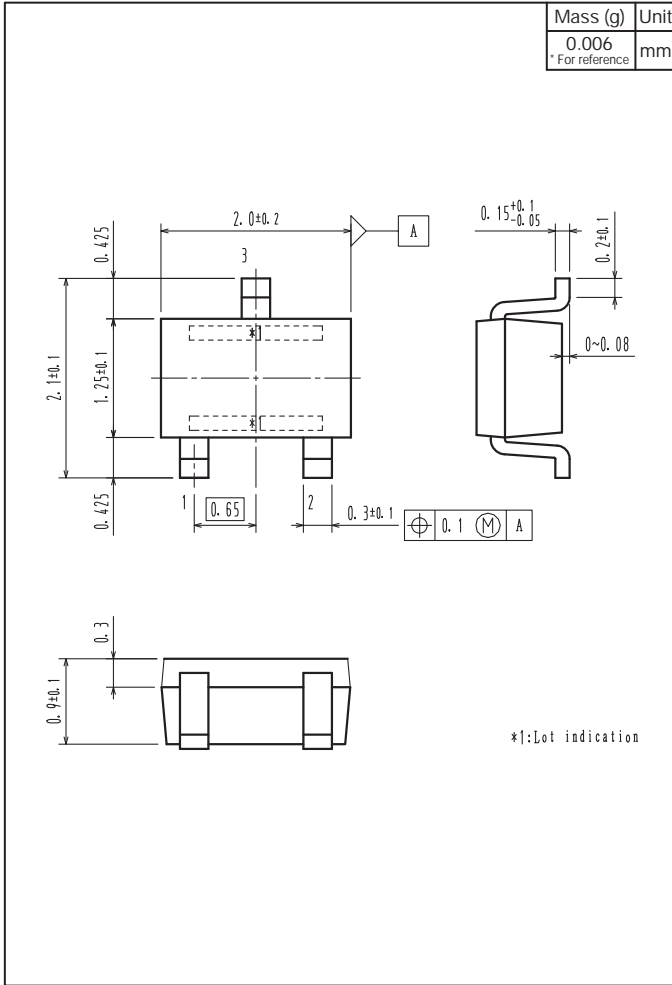
#### 2-2. Device placement direction



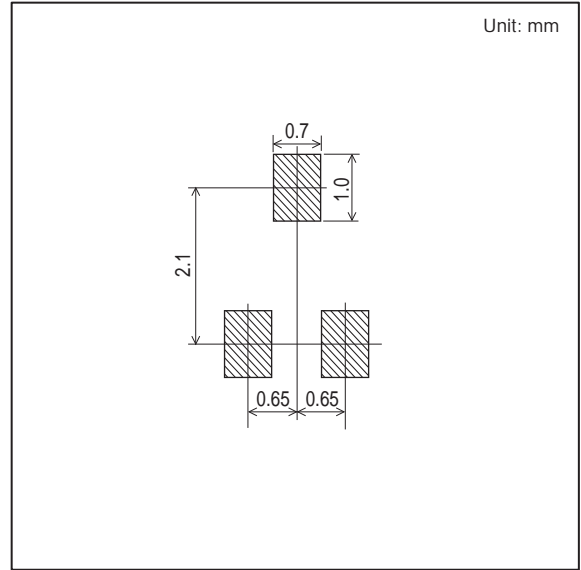
Those with one electrode terminal on the feed hole side.....TL

# 2SC5245A

## Outline Drawing 2SC5245A-4-TL-E



## Land Pattern Example



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